

Application Data Sheet

APPLICATION INFORMATION

Application Number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?: None

Number of CD Disks:

Number of Copies of CDs::

Sequence Submission?:

Computer Readable From (CRF)?: No

Number of Copies of CRF::

Title:: ULTRAVIOLET-LIGHT RADIATING APPARATUS,
WET ETCHING APPARATUS AND WET
ETCHING METHOD USING
ULTRAVIOLETLIGHT, AND METHOD OF
MANUFACTURING SEMICONDUCTOR DEVICE

Attorney Docket Number:: 403003

Request for Early Publication?: No

Request for Non-Publication?: No

Suggested Drawing Figure::

Total Drawing Sheets:: 6

Small Entity?: No

Latin Name::

Variety denomination name::

Petition Included?: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?: No

APPLICANT INFORMATION

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
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State or Prov. of Residence::
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State or Province of mailing address:: Ibaraki
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CORRESPONDENCE INFORMATION

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REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

DOMESTIC PRIORITY INFORMATION

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

FOREIGN APPLICATION INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed
Japan	2003-081776	03/25/03	Yes

ASSIGNEE INFORMATION

Assignee name:: Semiconductor Leading Edge Technologies, Inc.

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